



## Quad Driver

### Product Preview

ELECTRICALLY TESTED PER:  
100E512

The 100E512 is a quad driver with two pairs of OR/NOR outputs from each gate, and a common, buffered enable input. Using the data inputs the device can serve as an ECL memory address fan-out driver. Using just the enable input, the device serves as a clock driver, although the 100E511 is designed specifically for this purpose, and offers lower skew than the E512.

- 600 ps Max. Propagation Delay
- Common Enable Input
- Extended 100E  $V_{EE}$  Range of - 4.2 V to - 5.46 V
- 75 k $\Omega$  Input Pulldown Resistors

#### PIN NAME

| Pin                                     | Function          |
|-----------------------------------------|-------------------|
| $D_0 - D_3$                             | Data Inputs       |
| $\overline{EN}$                         | Enable Inputs     |
| $Q_{na} - Q_{nb}$                       | True Outputs      |
| $\overline{Q_{na}} - \overline{Q_{nb}}$ | Inverting Outputs |

## Military 100E512

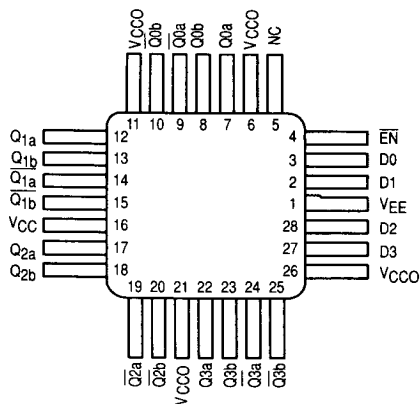


#### AVAILABLE AS

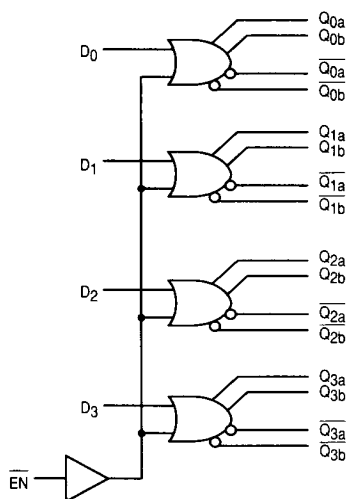
- 1) JAN: N/A
  - 2) SMD: N/A
  - 3) 883: Planned
- X = CASE OUTLINE AS FOLLOWS:

PACKAGE: NON-Compliant  
QFP: X

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#### LOGIC DIAGRAM



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MOTOROLA MILITARY MECL DATA  
5-50

# 100E512

**100E Series DC CHARACTERISTICS:**  $V_{EE} = -4.2 \text{ V to } -5.46 \text{ V}$ ,  $V_{CC} = V_{CCO} = \text{GND}$ ;  $-55^{\circ}\text{C to } +125^{\circ}\text{C}$

| Symbol    | Parameter           | Min   | Max   | Units         | TEST CONDITION APPLIED:               |                                |
|-----------|---------------------|-------|-------|---------------|---------------------------------------|--------------------------------|
| $V_{OH}$  | Output HIGH Voltage | -1025 | -880  | mV            | $V_{IN} = V_{IH}(\text{max})$         | Loading with                   |
| $V_{OL}$  | Output LOW Voltage  | -1810 | -1620 | mV            | or $V_{IN} = V_{IL}(\text{min})$      | $50\Omega$ to $-2.0 \text{ V}$ |
| $V_{OHA}$ | Output HIGH Voltage | -1035 |       | mV            | $V_{IN} = V_{IH}(\text{min})$         | Loading with                   |
| $V_{OLA}$ | Output LOW Voltage  |       | -1610 | mV            | or $V_{IN} = V_{IL}(\text{max})$      | $50\Omega$ to $-2.0 \text{ V}$ |
| $V_{IH}$  | Input HIGH Voltage  | -1165 | -880  | mV            | Guaranteed HIGH Signal for All Inputs |                                |
| $V_{IL}$  | Input LOW Voltage   | -1810 | -1475 | mV            | Guaranteed LOW Signal for All Inputs  |                                |
| $I_{IL}$  | Input LOW Current   | 0.5   |       | $\mu\text{A}$ | $V_{IN} = V_{IL}(\text{min})$         |                                |

**DC CHARACTERISTICS:**  $V_{EE} = V_{EE}(\text{min})$  to  $V_{EE}(\text{max})$ ,  $V_{CC} = V_{CCO} = \text{GND}$

| Symbol          | Parameter              | Limits  |     |          |     |         |     | Units | TEST CONDITION APPLIED: |
|-----------------|------------------------|---------|-----|----------|-----|---------|-----|-------|-------------------------|
|                 | Functional Parameters: | + 25° C |     | + 125° C |     | – 55° C |     |       |                         |
|                 |                        | Min     | Max | Min      | Max | Min     | Max |       |                         |
| I <sub>IH</sub> | Input High Current     |         |     |          |     |         |     | μA    |                         |
|                 | D                      |         | 200 |          | 200 |         | 200 |       |                         |
|                 | EN                     |         | 150 |          | 150 |         | 150 |       |                         |
| I <sub>EE</sub> | Power Supply Current   | 47      | 56  | 54       | 65  | 47      | 56  | mA    |                         |

**AC CHARACTERISTICS:**  $V_{EE} = V_{EE}(\text{min})$  to  $V_{EE}(\text{max})$ ,  $V_{CC} = V_{CCO} = \text{GND}$

| Symbol                 | Parameter                   | Limits  |     |          |     |         |     | Units | TEST CONDITION APPLIED: |
|------------------------|-----------------------------|---------|-----|----------|-----|---------|-----|-------|-------------------------|
|                        | Functional Parameters:      | + 25° C |     | + 125° C |     | – 55° C |     |       |                         |
|                        |                             | Min     | Max | Min      | Max | Min     | Max |       |                         |
| $t_{PLH}$<br>$t_{PHL}$ | Propagation Delay to Output |         |     |          |     |         |     |       |                         |
|                        | D                           | 200     | 600 | 200      | 600 | 200     | 600 | ps    |                         |
|                        | $\overline{EN}$             | 275     | 675 | 275      | 675 | 275     | 675 | ps    |                         |
| $t_{Skew}$             | Within-device Skew          |         |     |          |     |         |     |       |                         |
|                        | Dn to Qn, $\overline{Qn}$   | 80      |     | 80       |     | 80      |     | ps    | (Note 1)                |
|                        | Dna to Qnb                  | 40      |     | 40       |     | 40      |     | ps    | (Note 2)                |
| $t_r$<br>$t_f$         | Rise/Fall Times<br>20 - 80% | 275     | 700 | 275      | 700 | 275     | 700 | ps    |                         |

1. Within-device skew is defined as identical transitions on similar paths through a device.
2. Skew defined between common OR or common NOR outputs of a single gate.